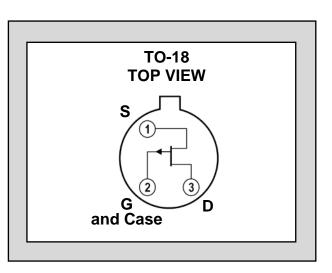
# LINEAR SYSTEMS

# Improved Standard Products<sup>®</sup>

FEATURES						
DIRECT REPLACEMENT FOR SILICONIX 2N5018						
ZERO OFFSET VOLTAGE						
LOW ON RESISTANCE 75Ω						
ABSOLUTE MAXIMUM RATINGS <sup>1</sup> @ 25 °C (unless otherwise stated)						
Maximum Temperatures						
Storage Temperature	-55 to 150°C					
Junction Operating Temperature -55 to 150°C						
Maximum Power Dissipation						
Continuous Power Dissipation <sup>3</sup>	500mW					
Maximum Currents						
Gate Current	-10mA					
Maximum Voltages						
Gate to Drain	30V					
Gate to Source	30V					

# **2N5018 SERIES**

## SINGLE P-CHANNEL JFET SWITCH



### STATIC ELECTRICAL CHARACERISTICS @25°C (unless otherwise stated)

SYM.	CHARACTERISTIC TYP 2N5018 2N5019		019	UNITS	CONDITIONS				
5111.	CHARACTERISTIC	ITP	MIN	MAX	MIN	MAX		CONDITIONS	
BV <sub>GSS</sub>	Gate to Source Breakdown Voltage		30		30			$I_G = 1 \mu A,  V_{DS} = 0 V$	
V <sub>GS(off)</sub>	Gate to Source Cutoff Voltage			10		5	V	$V_{DS} = -15V, I_D = -1\mu A$	
	Drain to Source On Voltage			-0.5				$V_{GS} = 0V, I_D = -6mA$	
V <sub>DS(on)</sub>	Drain to Source On Voltage					-0.5		$V_{GS} = 0V, I_D = -3mA$	
IDSS	Drain to Source Saturation Current <sup>2</sup>		-10		-5		mA	$V_{DS}$ = -20V, $V_{GS}$ = 0V	
lgss	Gate Leakage Current			2		2	nA	$V_{GS} = 15V, V_{DS} = 0V$	
1	Drain Cutoff Current			-10		-10	ПА	$V_{DS} = -15V, V_{GS} = 12V$	
I <sub>D(off)</sub>						-10	μA	$V_{DS}$ = -15V, $V_{GS}$ = 7V	
Idgo	Drain Reverse Current			-2		-2	nA	$V_{DG} = -15V, I_S = 0A$	
<b>r</b> DS(on)	Drain to Source On Resistance			75		150	Ω	$I_D = -1mA$ , $V_{GS} = 0V$	

#### DYNAMIC ELECTRICAL CHARACTERISTICS @25°C (unless otherwise stated)

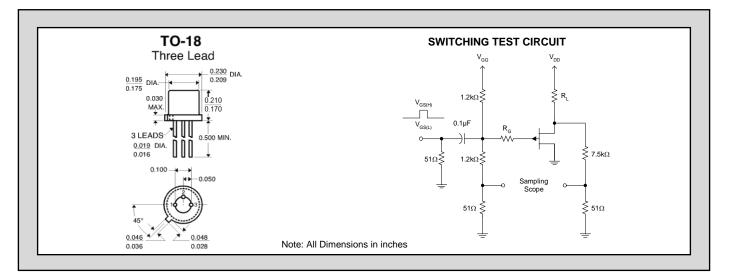
SYM.	CHARACTERISTIC	ТҮР	2N5018		2N5019		UNITS	CONDITIONS	
5 T IVI.	CHARACTERISTIC	ITF	MIN	MAX MIN MAX					
r <sub>ds(on)</sub>	Drain to Source On Resistance			75		150	Ω	$I_D = -100\mu A, V_{GS} = 0V$ f = 1kHz	
Ciss	Input Capacitance			45		45		$V_{DS} = -15V, V_{GS} = 0V$ f = 1MHz	
Crss	Reverse Transfer Capacitance			10			pF	$V_{DS} = 0V, V_{GS} = 12V$ f = 1MHz	
Urss	Reverse Transier Capacitance					10		$V_{DS} = 0V, V_{GS} = 7V$ f = 1MHz	

#### SWITCHING CHARACTERISTICS (max)

SYM.	CHARACTERISTIC	2N5018	2N5019	UNITS
t <sub>d(on)</sub>	Turn On Time	15	15	
tr	rum On Time	20	75	
t <sub>d(off)</sub>	Turn Off Time	15	25	ns
tr		50	100	

#### SWITCHING CIRCUIT CHARACTERISTICS

SYM.	2N5018	2N5019
Vdd	-6V	-6V
Vgg	12V	8V
R∟	910Ω	1.8KΩ
RG	220Ω	390Ω
I <sub>D(on)</sub>	-6mA	-3mA
V <sub>GS(H)</sub>	0V	0V
V <sub>GS(L)</sub>	12V	7V



## NOTES

- 1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
- 2. Pulse test: PW  $\leq$  300µs, Duty Cycle  $\leq$  3%
- 3. Derate 3mW/°C above 25°C.

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#### $\mathbf{SS}$

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